Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
85V	4.3mΩ@10V	90A

合肥矽普半导体
Siliup Semiconductor Technology Co.Ltd
技术 品质 服务
www.siliup.com

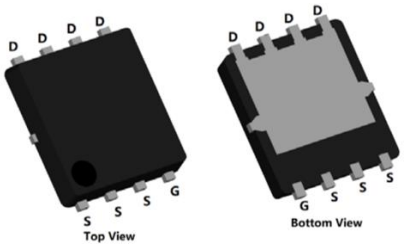
Feature

- Fast Switching
- Low Gate Charge and Rdson
- Advanced Split Gate Trench Technology
- 100% Single Pulse avalanche energy Test

Applications

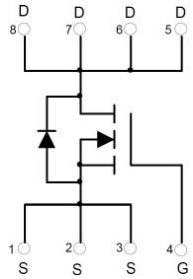
- Power switching application
- DC-DC Converter
- Power Management

Package

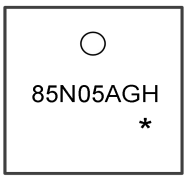


PDFN5X6-8L

Circuit diagram



Marking



85N05AGH :Device Code
*** :Month Code**

Order Information

Device	Package	Unit/Tape
SP85N05AGHNK	PDFN5X6-8L	5000

Absolute maximum ratings (Ta=25℃ unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	85	V
Gate-Source Voltage	V_{GS}	±20	V
Continuous Drain Current (Tc=25℃)	I_D	90	A
Continuous Drain Current (Tc=100℃)	I_D	60	A
Pulsed Drain Current	I_{DM}	360	A
Single Pulse Avalanche Energy[1]	E_{AS}	784	mJ
Power Dissipation (Tc=25℃)	P_D	125	W
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	1	℃/W
Storage Temperature Range	T_{STG}	-55 to 150	℃
Operating Junction Temperature Range	T_J	-55 to 150	℃

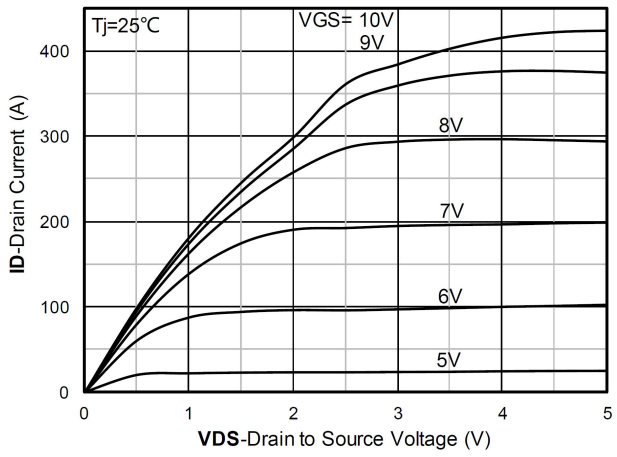
Electrical characteristics (Ta=25℃, unless otherwise noted)

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	ID = 250μA, VGS = 0V	85	90	-	V
Drain Cut-Off Current	I_{DSS}	VDS = 68V, VGS = 0V	-	-	1	μA
Gate Leakage Current	I_{GSS}	VGS = ±20V, VDS = 0V	-	-	±0.1	
Gate Threshold Voltage	$V_{GS(th)}$	VDS = VGS, ID = 250μA	2	3	4	V
Drain-Source ON Resistance	$R_{DS(ON)}$	VGS = 10V, ID = 20A	-	4.3	5.5	mΩ
Dynamic Characteristics						
Input Capacitance	C_{iss}	VDS =40V, VGS = 0V, f = 1.0MHz	-	3543	-	pF
Output Capacitance	C_{oss}		-	1058	-	
Reverse Transfer Capacitance	C_{rss}		-	23	-	
Total Gate Charge	Q_g	VDS=40V , VGS=10V , ID=165A	-	49	-	nC
Gate-Source Charge	Q_{gs}		-	16	-	
Gate-Drain Charge	Q_{gd}		-	13	-	
Switching Characteristics						
Turn-On Delay Time	$t_{d(on)}$	VGS = 10V, VDS = 40V, ID=165A , RG = 1.6Ω	-	17	-	nS
Rise Time	t_r		-	25	-	
Turn-Off Delay Time	$t_{d(off)}$		-	36	-	
Fall Time	t_f		-	15	-	
Drain-Source Body Diode Characteristics						
Source-Drain Diode Forward Voltage	V_{SD}	I_S = 1A, V_{GS} = 0V	-	-	1.2	V
Maximum Body-Diode Continuous Current	I_S		-	-	90	A
Reverse Recovery Time	T_{rr}	I_S=20A, di/dt=100A/us, TJ=25℃	-	62	-	nS
Reverse Recovery Charge	Q_{rr}		-	103	-	nC

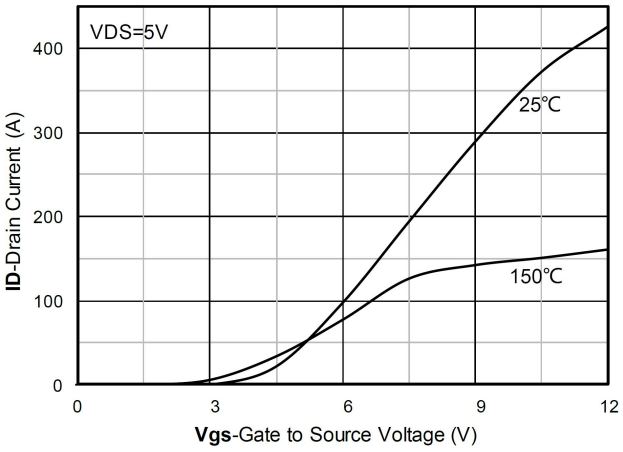
Note :

1. The test condition is VDD=45V,VGS=10V,L=0.5mH,RG=25Ω

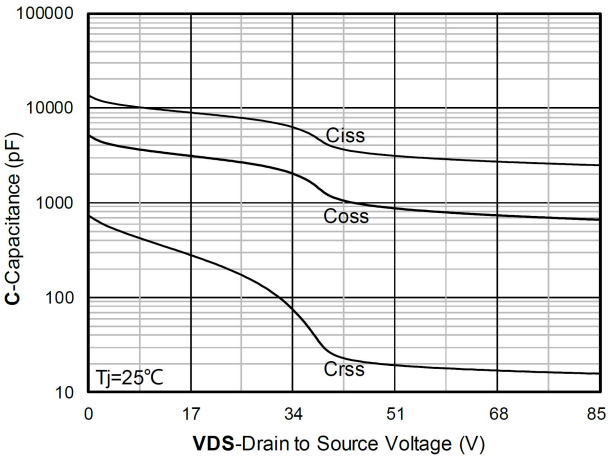
Typical Characteristics



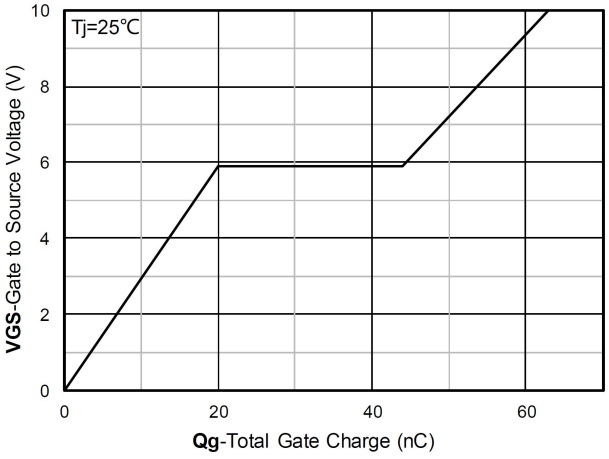
Output Characteristics



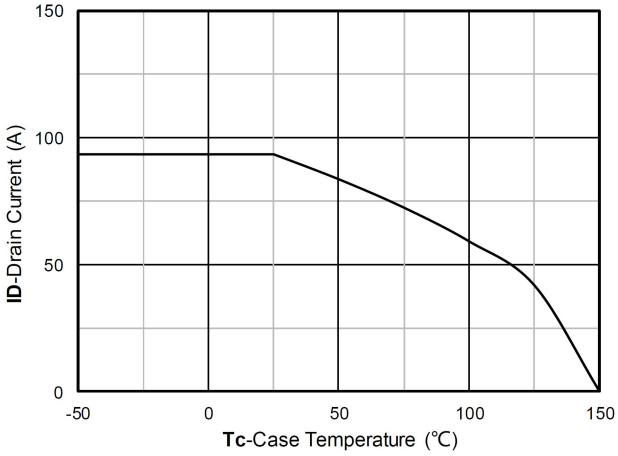
Transfer Characteristics



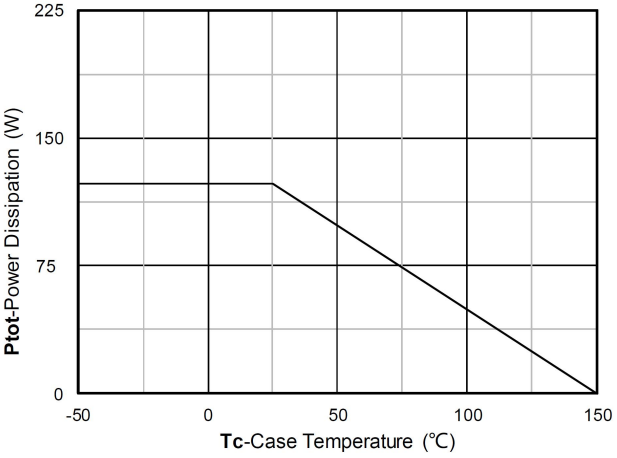
Capacitance Characteristics



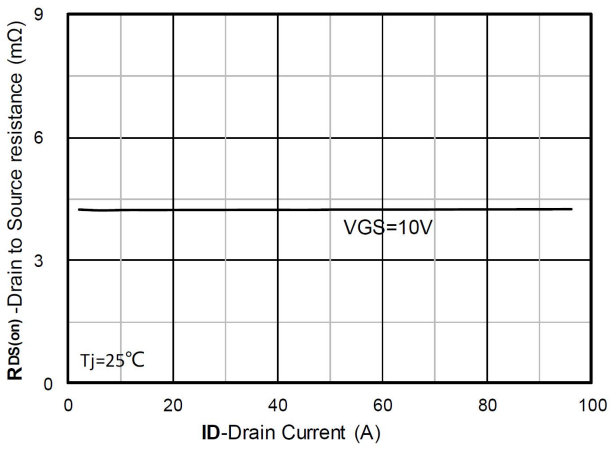
Gate Charge



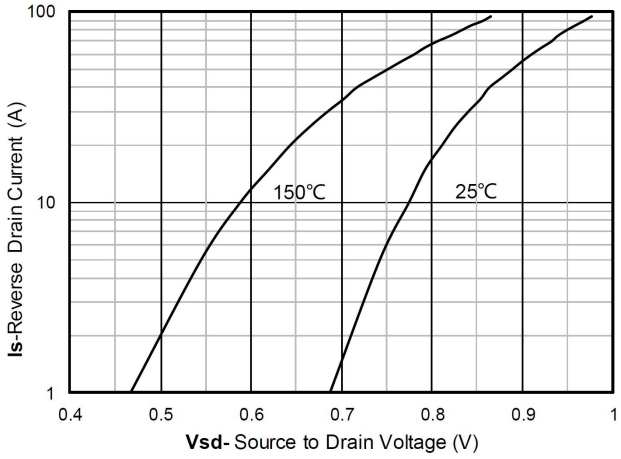
Current dissipation



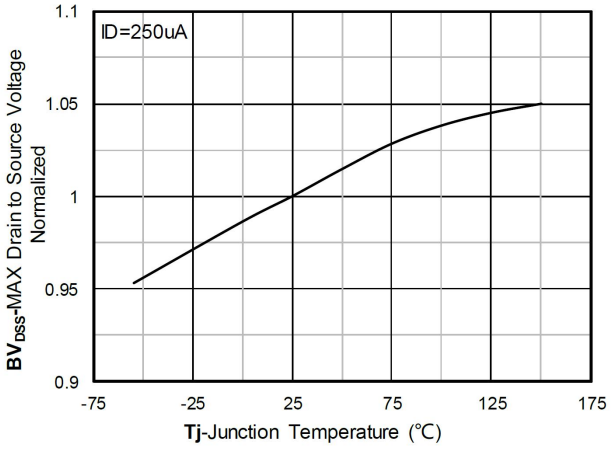
Power dissipation



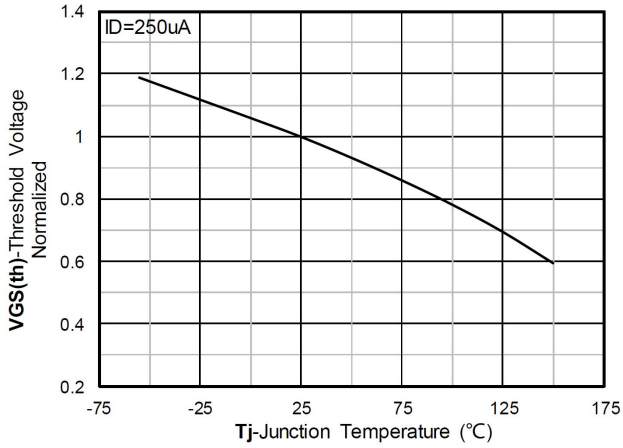
RDS(on) VS Drain Current



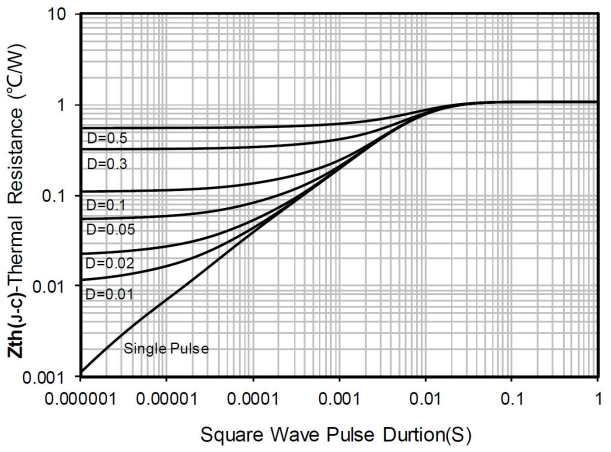
Forward characteristics of reverse diode



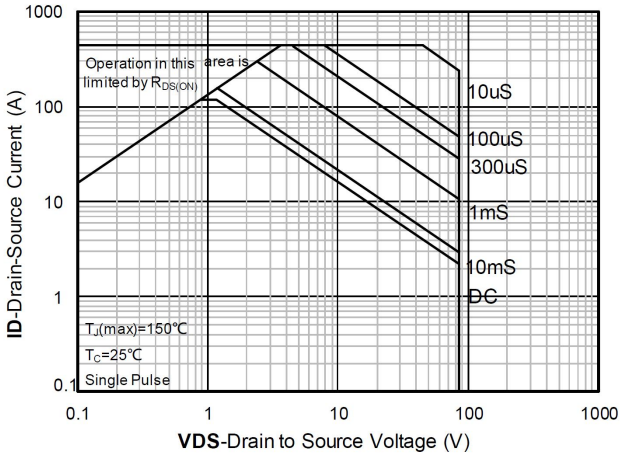
Normalized breakdown voltage



Normalized Threshold voltage

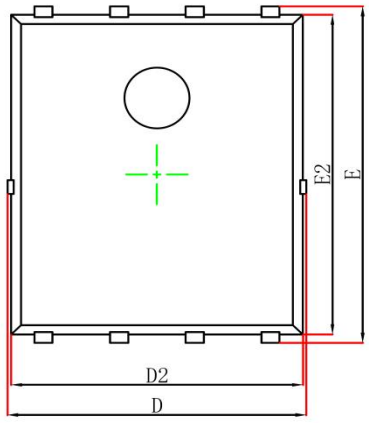


Maximum Transient Thermal Impedance

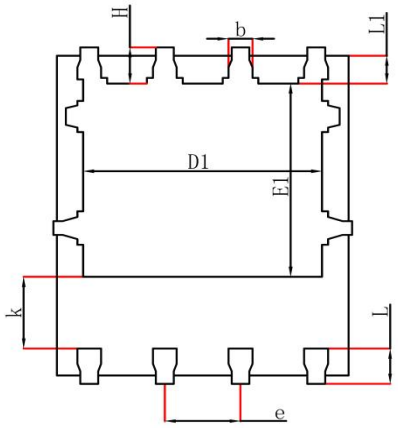


Safe Operation Area

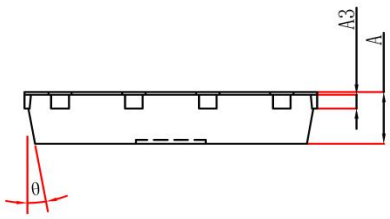
PDFN5X6-8L Package Information



Top View
[顶视图]



Bottom View
[背视图]



Side View
[侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.000	0.035	0.039
A3	0.254REF.		0.010REF.	
D	4.944	5.096	0.195	0.201
E	5.974	6.126	0.235	0.241
D1	3.910	4.110	0.154	0.162
E1	3.375	3.575	0.133	0.141
D2	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
k	1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
e	1.270TYP.		0.050TYP.	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°